

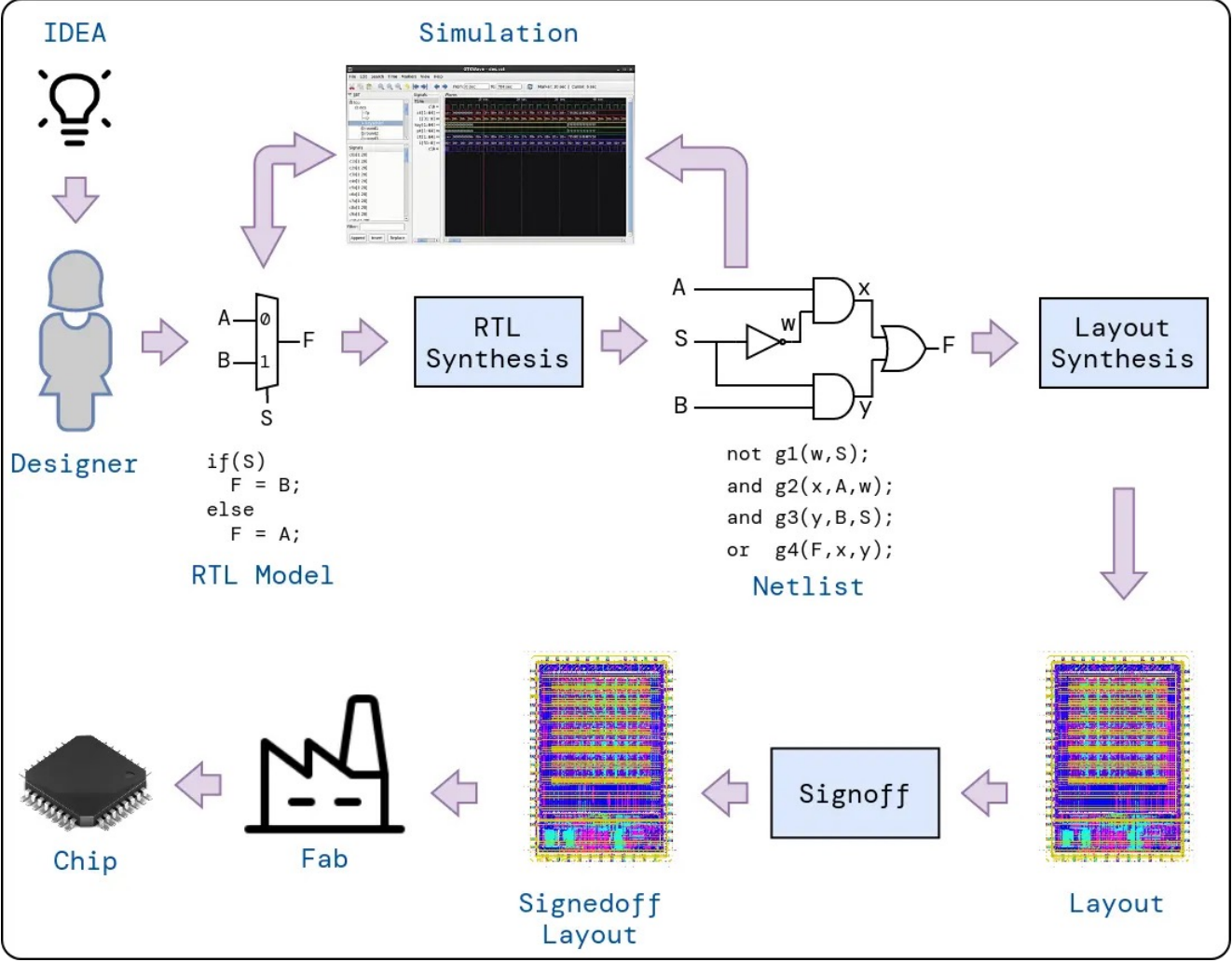
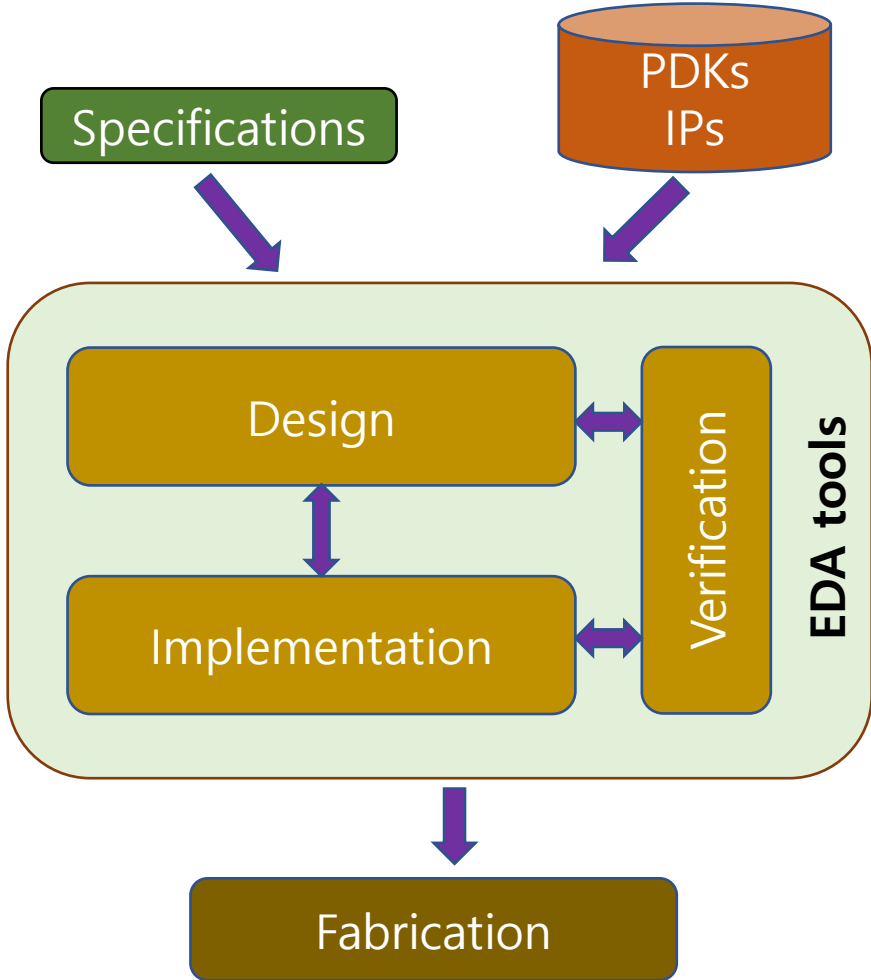


ASIC Physical Implementation Using Openlane2

Nguyen Dao

nguyen.dao@manchester.ac.uk

ASIC Design Flow



Opensource EDA tools and PDKs

Opensource tools

- Xschem – Analog/mixed signal design
- Yosys – RTL synthesis
- Icarus/Iverilog + GTKWave – synthesis/simulation and waveform viewer
- Openroad – Physical implementation
- OpenSTA – Timing/Power analysis
- Magic/Klayout – Layout/DRC check
- Netgen – LVS check
- CVC – Circuit Validity checker
- https://xschem.sourceforge.io/stefan/xschem_man/xschem_man.html
- <https://github.com/YosysHQ/yosys>
- <http://iverilog.icarus.com>
- <https://gtkwave.sourceforge.net>
- <https://github.com/The-OpenROAD-Project/OpenLane>
- <http://opencircuitdesign.com/magic/>
- <https://www.klayout.de>
- <https://github.com/hpretl/iic-osic-tools>

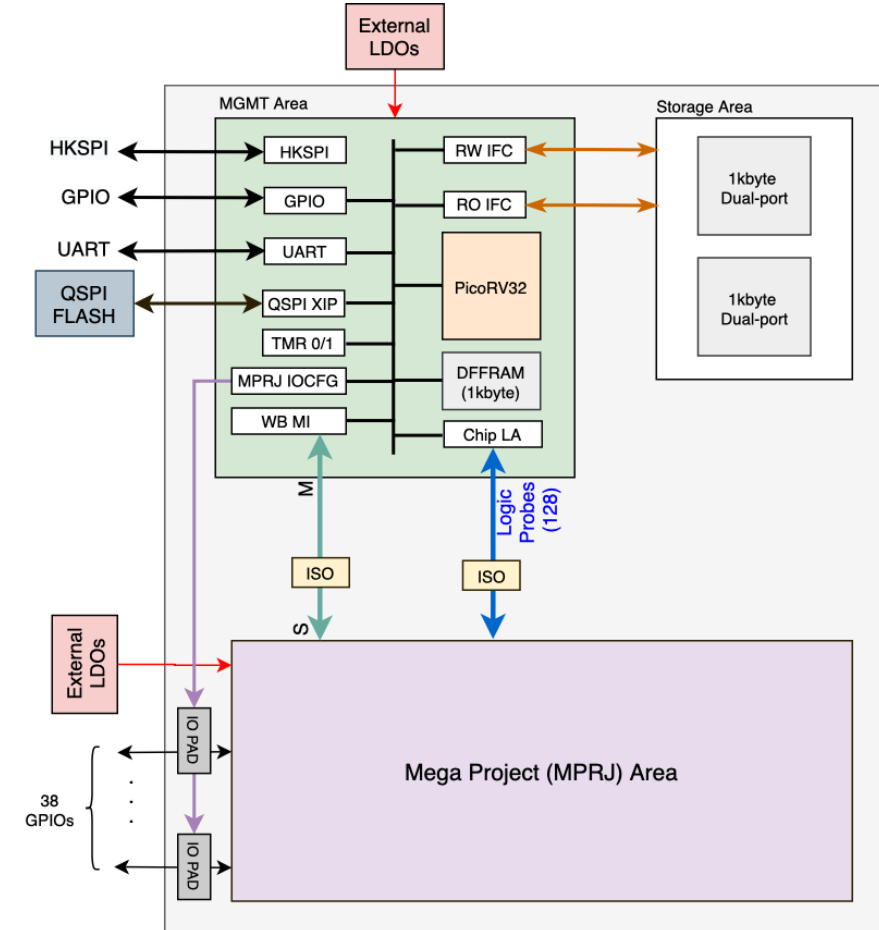
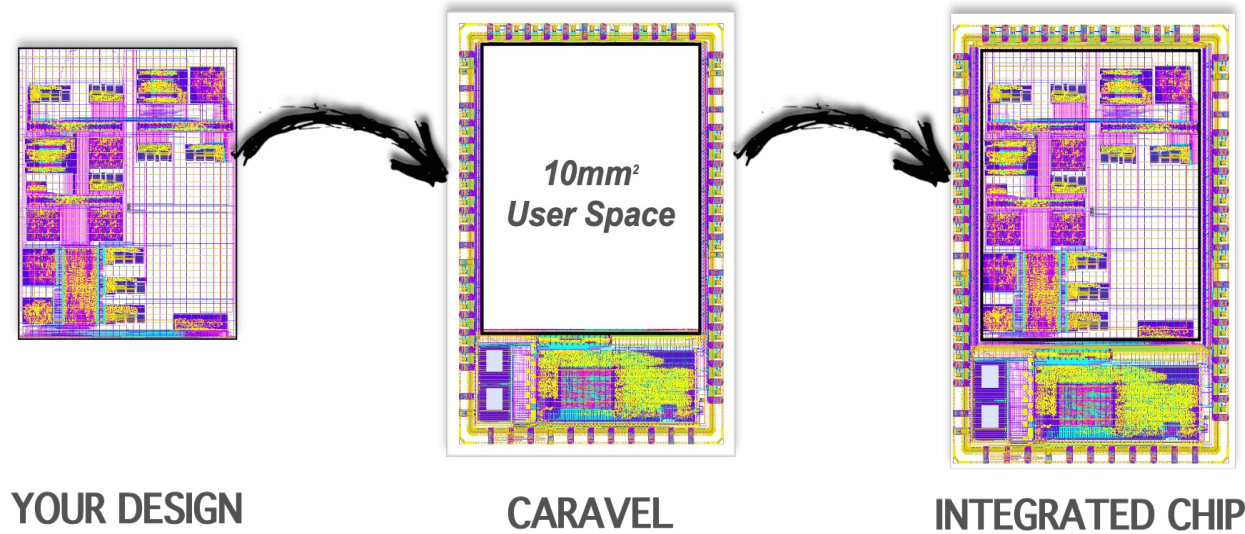
Opensource PDKs

- GF180MCU (GlobalFoundries 180nm)
- Sky130 – Sky90-FDSOI (Skywater 130nm – 90nm)
- FreePDK45 (45nm) - FreePDK15 (15nm)
- ASAP7 (Predictive 7nm Process)
- FreePDK3 (Predictive 3nm Process)
- <https://skywater-pdk.readthedocs.io/en/main/>
- <https://opensource.googleblog.com/2022/07>
- <https://eda.ncsu.edu/>
- <https://asap.asu.edu>

eFabless Caravel SoC

- **Caravel SoC** is composed of the harness frame, the **management area** and the **user project area**
- The management SoC is a RISC-V based SoC that includes several peripherals such as UART, GPIOs etc.
- The management SoC runs firmware that can be used to configure the IOs, control the power supply and observe/control signals to/from User project wrapper

- User project area (2.92mm x 3.52 mm) has fixed 38 GPIOs, 128 Logic analyzer probes and Wishbone port connections to management SoC



Openlane2 Design Flow

1. Synthesis

- o Yosys & Verilator – RTL synthesis
- o ABC – technology mapping
- o OpenSTA – static timing analysis

2. Floorplan and PDN

- o Init_fp – core area planning
- o Ioplacer – macros/ios placement
- o Pdn – implement power distribution network
- o Tapcell – insert welltap/decap cells

3. Placement

- o RePlace – perform global placement
- o Resizer – optimize the design
- o OpenDP – perform detailed placements

4. CTS

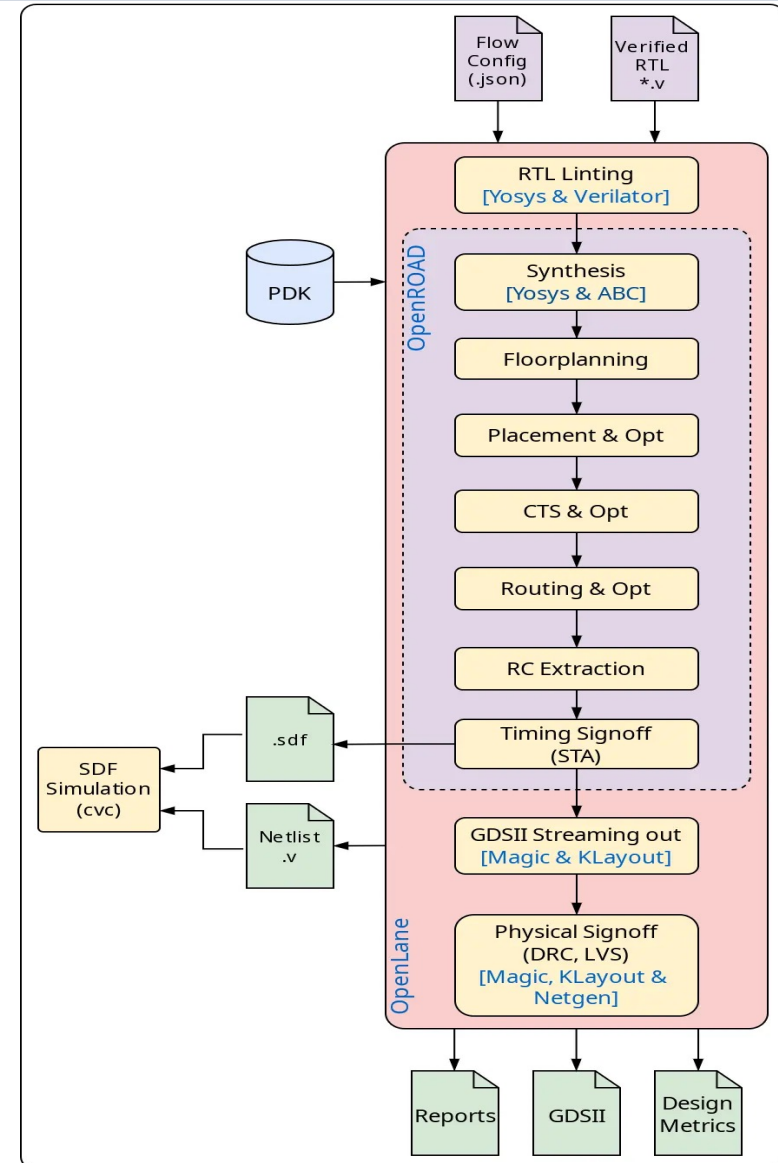
- o TritonCTS – Clock Tree Synthesis

5. Routing

- o FastRout/CU-GR – perform global routing
- o TritonRoute – perform detailed routing
- o SPEF-Extractor - perform parasitic extraction

6. GDSII Generation

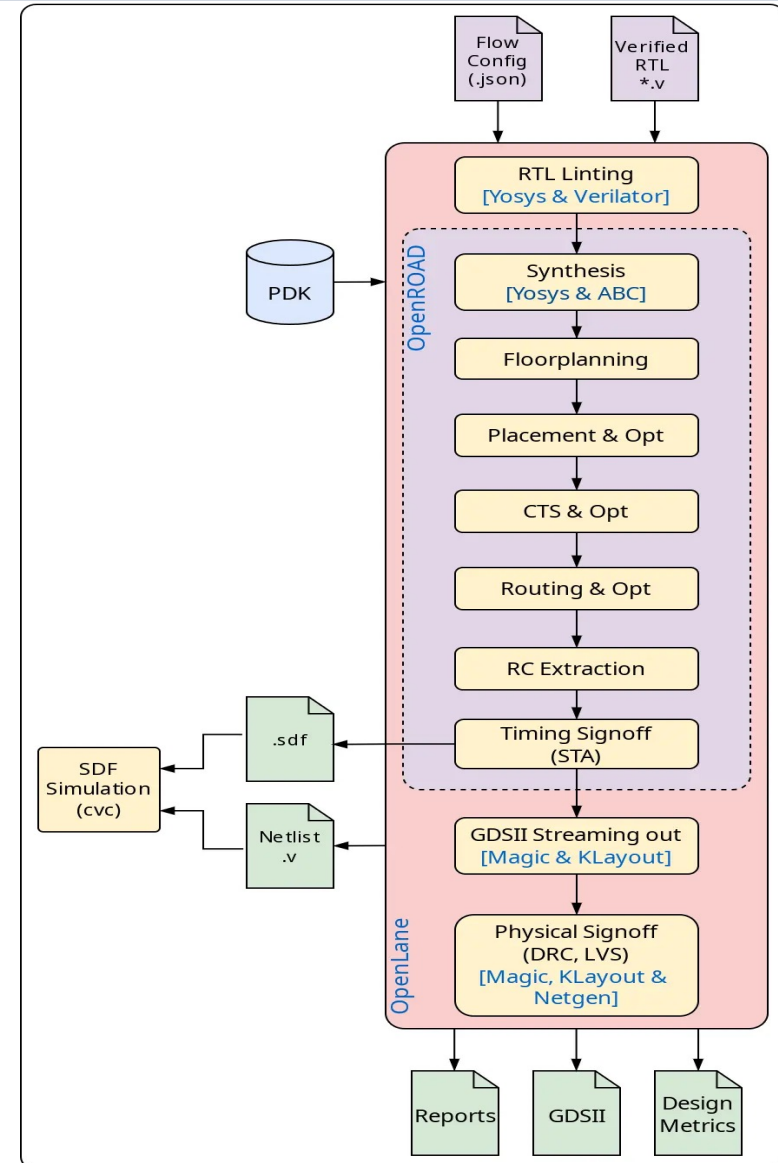
- o Magic/Klayout – stream out the final GDSII layout file



Openlane2 Design Flow

Hardening strategies:

- 1. Maro-First Hardening:** Harden the user macro(s) initially and incorporate them into the user project wrapper without top-level standard cells. Ideal for a smaller designs, as this approach significantly reduces Placement and Routing (OnR) and signoff time.
- 2. Full-Wrapper Flattening:** Merge the user macro(s) with the user_project_wrapper, covering the entire wrapper area. While this method demands more time and iterations for PnR and signoff, it ultimately enhances performance, making it suitable for design requiring the full wrapper area.
- 3. Top-Level Integration:** Place the user macro(s) within the wrapper alongside standard cells at the top level, This method is typically chosen to introduce buffering at the top level, fitting scenarios where such an approach is necessary



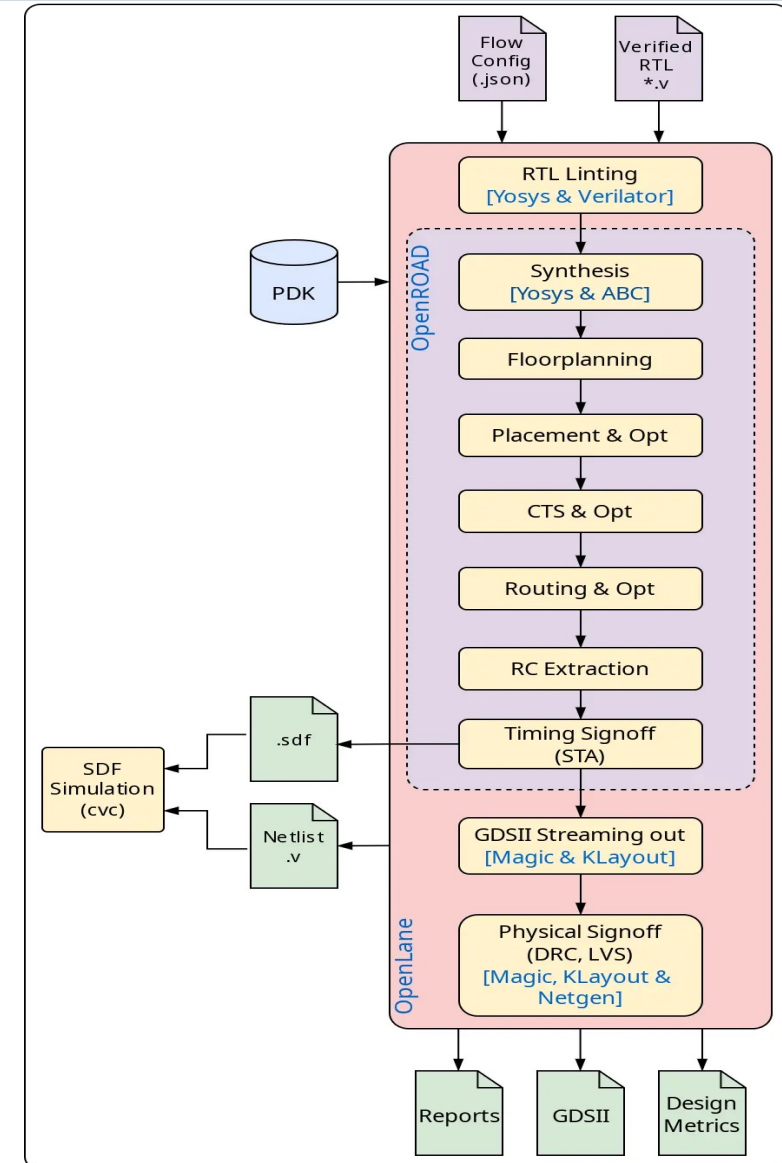
Openlane2 Design Flow

Hardening strategies:

1. Prepare the design (RTL)
2. Set the flow constraints .json, timing constraints .sdc, pin placement .cfg
3. Run the flow
`$openlane <dir_to_json_file>/config.json`
4. Check the results

```
{  
  "DESIGN_NAME": "aes_wb_wrapper",  
  "FP_PDN_MULTILAYER": false,  
  "CLOCK_PORT": "wb_clk_i",  
  "CLOCK_PERIOD": 25,  
  "VERILOG_FILES": [  
    "dir:../../../../secworks_aes/src/rtl/aes.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_core.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_decipher_block.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_encipher_block.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_inv_sbox.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_key_mem.v",  
    "dir:../../../../secworks_aes/src/rtl/aes_sbox.v",  
    "dir:../../../../verilog/rtl/aes_wb_wrapper.v"  
  ],  
  "FP_CORE_UTIL": 40  
}
```

config.json



Openlane2 Design Flow

Hardening strategies:

1. Prepare the design (RTL)

2. Set the flow constraints .json, timing constraints .sdc, pin placement .cfg

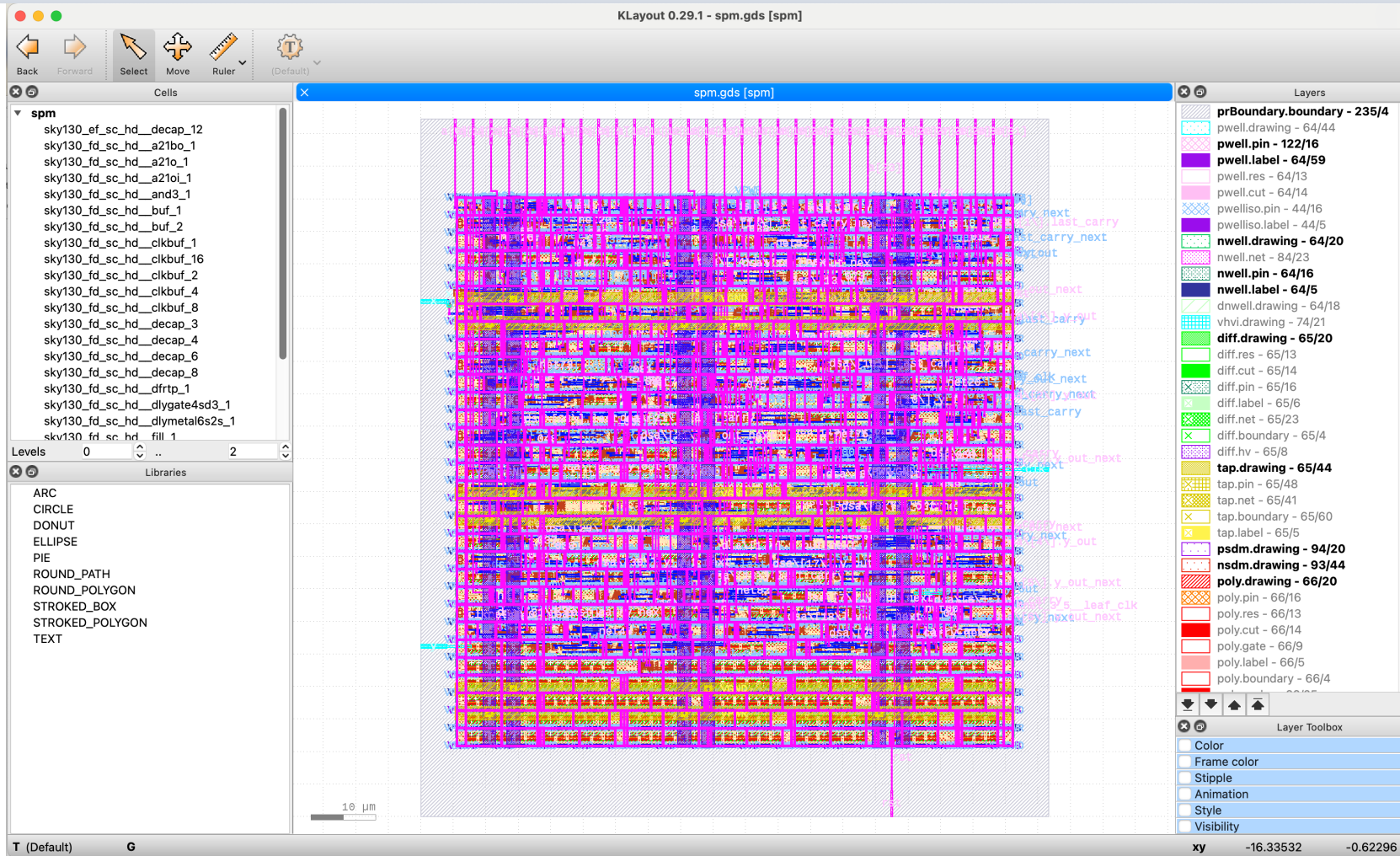
3. Run the flow

```
$openlane <dir_to_json_file>/config.json
```

4. Check the results

```
E-LOSXGBE1WfV:runs x19637nd$ ls RUN_2024-08-08_00-02-53/
01-verilator-lint
02-checker-linttimingconstructs
03-checker-linterrors
04-checker-lintwarnings
05-yosys-jsonheader
06-yosys-synthesis
07-checker-yosysunmappedcells
08-checker-yosyssynthchecks
09-checker-netlistassignstatements
10-openroad-checksdcfiles
11-openroad-checkmacroinstances
12-openroad-stapreprepr
13-openroad-floorplan
14-odb-checkmacroantennaproperties
15-odb-setpowerconnections
16-odb-manualmacroplacement
17-openroad-cutrows
18-openroad-tapendcapinsertion
19-odb-addpdnobstructions
20-openroad-generatepdn
21-odb-removepdnobstructions
22-odb-addroutingobstructions
23-openroad-globalplacementskipio
24-openroad-ioplacement
25-odb-customioplacement
26-odb-applydeftemplate
27-openroad-globalplacement
28-odb-writeverilogheader
29-checker-powergridviolations
30-openroad-stamidpnr
31-openroad-repairedesignpostgpl
32-openroad-detailedplacement
33-openroad-cts
34-openroad-stamidpnr-1
35-openroad-resizertimingpostcts
36-openroad-stamidpnr-2
37-openroad-globalrouting
38-openroad-checkantennas
39-odb-diodesonports
40-openroad-repairantennas
41-openroad-stamidpnr-3
42-openroad-detailedrouting
43-odb-removeroutingobstructions
44-openroad-checkantennas-1
45-checker-trdrc
46-odb-reportdisconnectedpins
47-checker-disconnectedpins
48-odb-reportwirelength
49-checker-wirelength
50-openroad-fillinsertion
51-openroad-rcx
52-openroad-stapostpnr
53-openroad-irdropreport
54-magic-streamout
55-klayout-streamout
56-magic-writelef
57-odb-checkdesignantennaproperties
58-klayout-xor
59-checker-xor
60-magic-drc
61-klayout-drc
62-checker-magicdrc
63-checker-klayoutdrc
64-magic-spiceextraction
65-checker-illegaloverlap
66-netgen-lvs
67-checker-lvs
68-checker-setupviolations
69-checker-holdviolations
70-checker-maxslewviolations
71-checker-maxcapviolations
72-misc-reportmanufacturability
error.log
final
flow.log
resolved.json
tmp
warning.log
```


Openlane2 Design Flow



check the final layout gds with Klayout:

```
$openlane --last-run --flow openinklayout openlane/examples/spm/config.json
```

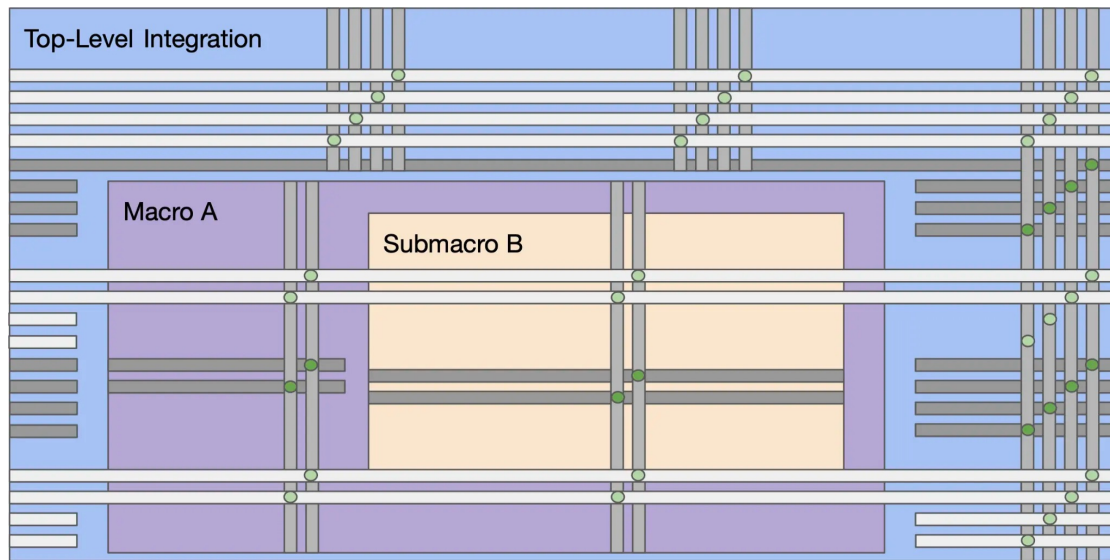
Openlane2 Design Flow

Macro integration:

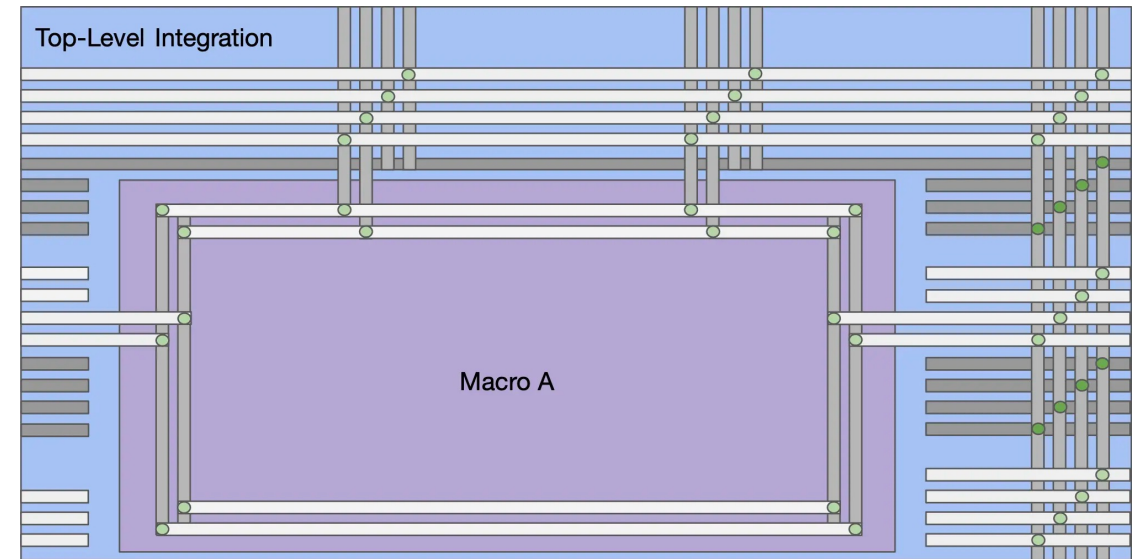
- **Hierarchical method:** saves space, but less routing layers available for the macros
- **Ring method:** Uses more space, allow any arbitrarily-nested macro to use the full routing layer stack. Useful if routing very complex macros.

All macros should be hardened with the following options:

- FP_PDN_CORE_RING
- FP_PDN_HORIZONTAL_LAYER
- FP_PDN_CORE_HWIDTH
- FP_PDN_CORE_VWIDTH
- FP_PDN_CORE_HOFFSET
- FP_PDN_CORE_VOFFSET
- FP_PDN_CORE_HSPACING
- FP_PDN_CORE_VSPACING



Macro integration using power straps



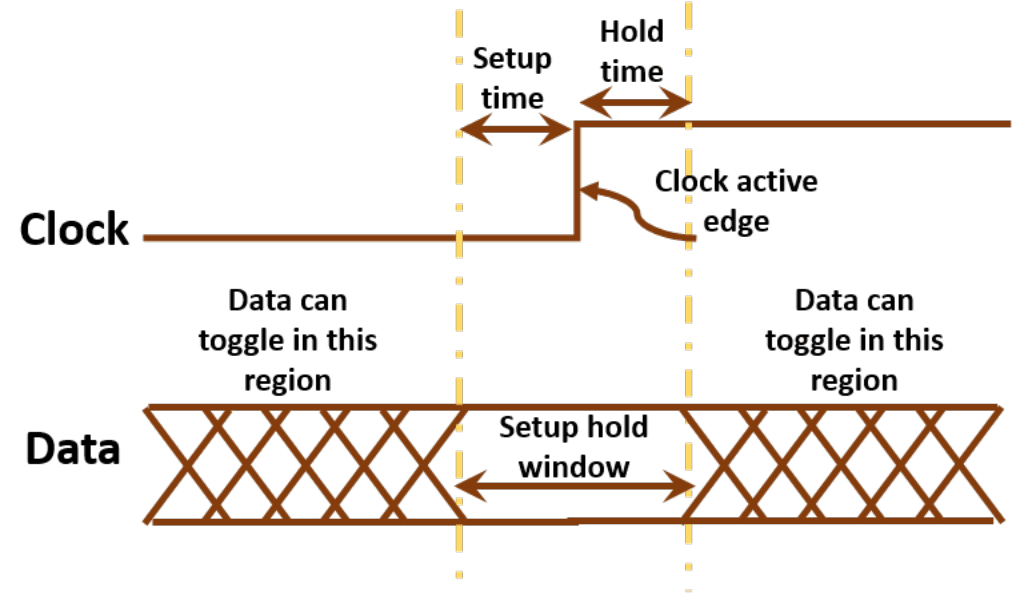
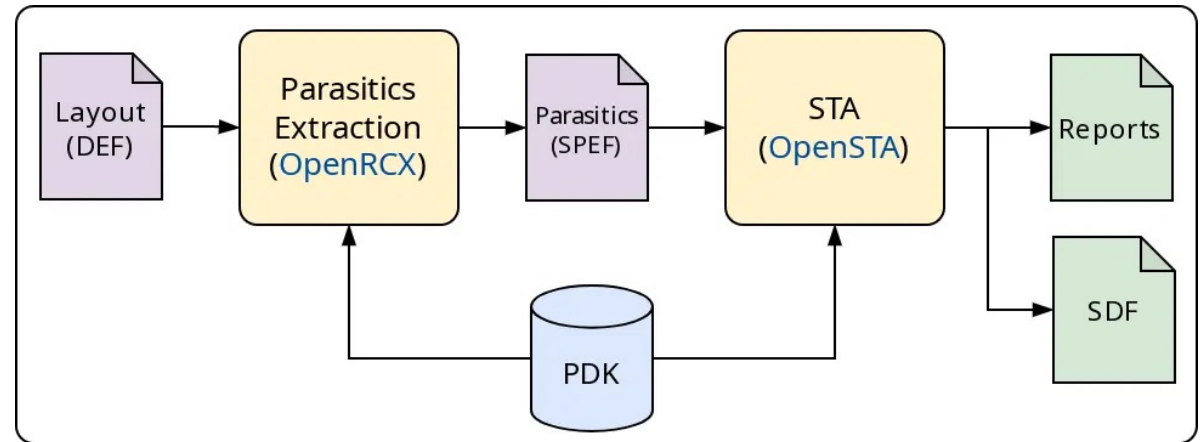
Macro integration using power ring

Openlane2 Design Flow

Static Timing Analysis (STA): the STA tool identified the design timing paths and then calculates the data's earliest and largest actual and required arrival times at every timing path endpoint.

If the data arrives after (setup checking) or before (hold checking) it is required, we have a timing violation (negative slack)

STA makes sure that a circuit will correctly perform its function (but tells nothing about the correctness of that function)



Openlane2 Design Flow

Timing corner: to ensure a chip can work properly under various conditions, the design must be analysed in different timing corners.

- Parasitic/Interconnect corners (capacitance, resistance)
- Transistor corners (fast, typical, slow)
- Temperature
- Voltage

Common EDA files incorporate these corners:

.spef – Parasitic/interconnect corners

.spice – interconnect and transistor corners

.lib – characteristics of a cell/macro at a full corner

Name	Process {NMOS, PMOS}	Voltage (V)	Temperature (C)	Corresponding File
"tt_025C_1v80"	{T, T}	1.8	25	sky130_fd_sc_hd__tt_025C_1v80.lib
"ss_100C_1v60"	{S, S}	1.6	100	sky130_fd_sc_hd__ss_100C_1v60.lib
"ff_n40C_1v95"	{F, F}	1.95	-40	sky130_fd_sc_hd__ff_n40C_1v95.lib

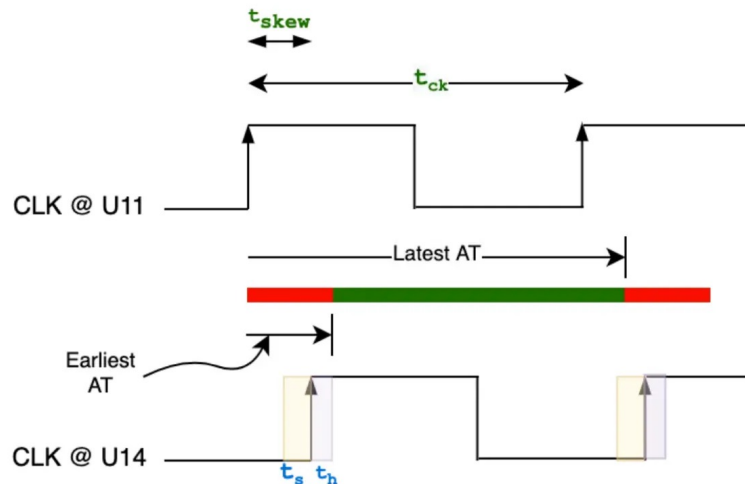
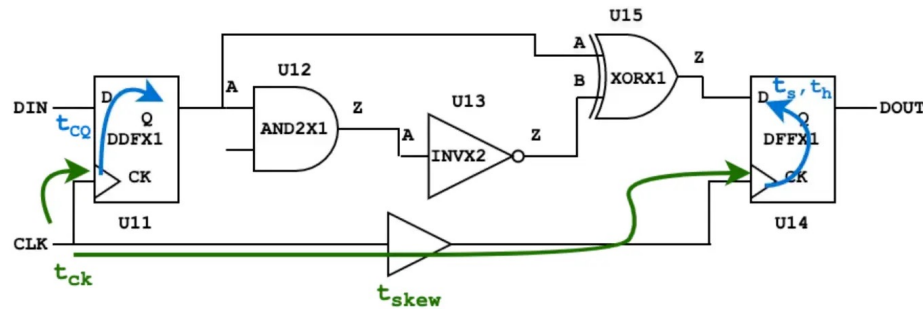
PVT: corner data stored in LIB

Name	Description	Corresponding Technology LEF	Corresponding Ruleset
"nom"	The nominal interconnect corner	sky130_fd_sc_hd__nom.tlef	rules.openrcx.sky130A.nom.calibre
"min"	The minimal interconnect corner	sky130_fd_sc_hd__min.tlef	rules.openrcx.sky130A.min.calibre
"max"	The maximum interconnect corner	sky130_fd_sc_hd__max.tlef	rules.openrcx.sky130A.max.calibre

Corner data stored in TECH_LEFS and RCX_TULESETS

Openlane2 Design Flow

Timing closure:



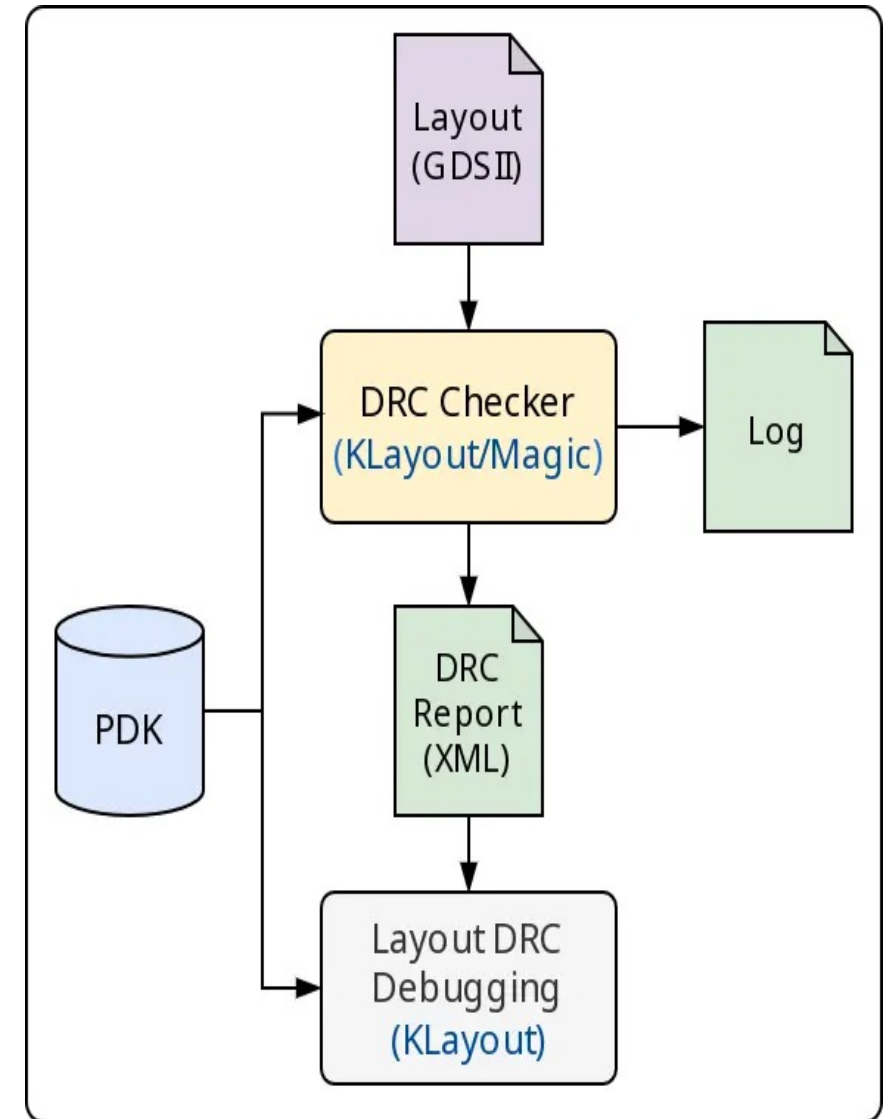
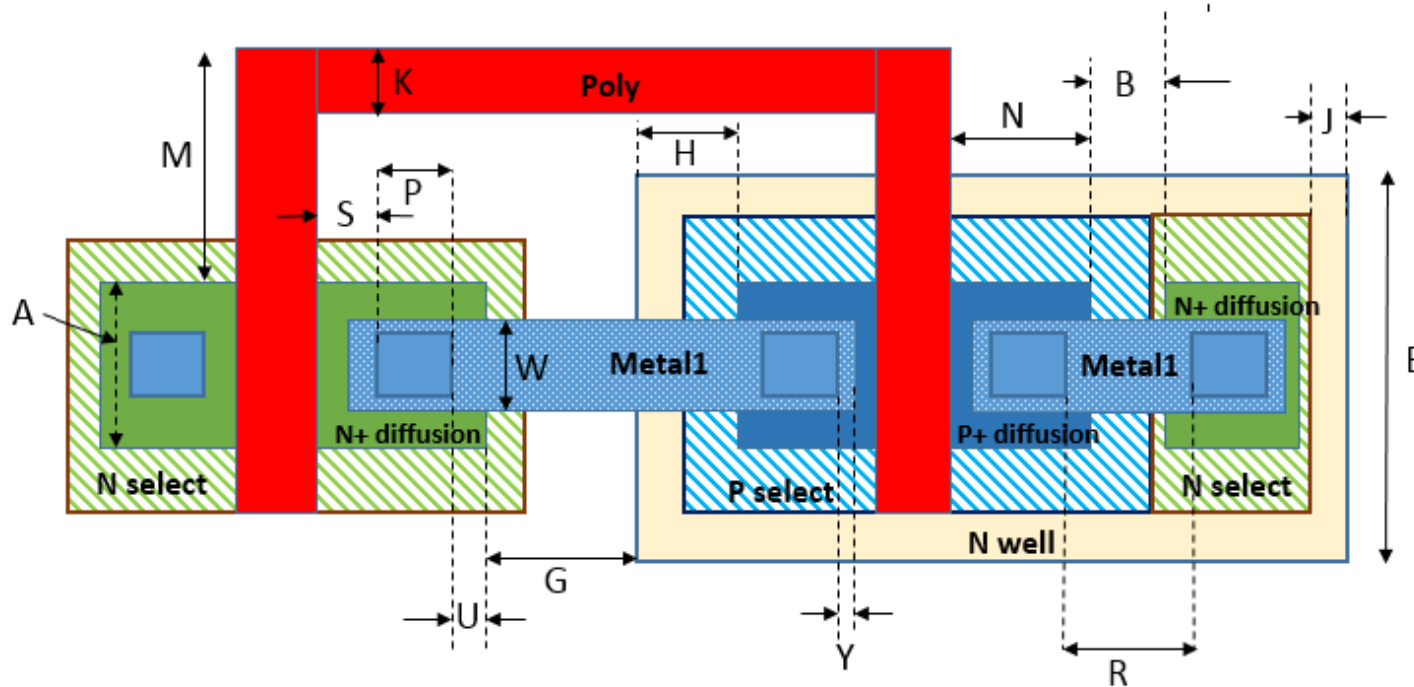
Timing constraints need to be set to help the tool analyse and optimize the design. The timing constraints are defined in SDC file (.sdc) such as create_clock, set_input_delay, set_output_delay, set_load, set_drive, etc.

Parameter	Use
RUN_POST_CTS_RESIZER_TIMING	Specifies whether design timing optimizations should be performed immediately after placement and CTS or not.
PL_RESIZER_SETUP_SLACK_MARGIN	Used to guide timing optimization after placement. It instructs the optimizer not to stop at zero slack and try to achieve a positive timing slack.
PL_RESIZER_HOLD_SLACK_MARGIN	Used to guide timing optimization after placement. It instructs the optimizer not to stop at zero slack and try to achieve a positive timing slack.
PL_RESIZER_HOLD_MAX_BUFFER_PCT	Maximum % of hold buffers to insert to fix hold vios. (PL/CTS)
PL_RESIZER_SETUP_MAX_BUFFER_PCT	Maximum % of hold buffers to insert to fix setup vios. (PL/CTS)
PL_RESIZER_ALLOW_SETUP_VIOS	Allow setup violations while fixing hold violations after placement and CTS.
RUN_POST_GRT_RESIZER_TIMING	Enable/disable timing optimizations after global routing. This is an experimental feature in OpenROAD and crashes may occur.
GRT_RESIZER_SETUP_SLACK_MARGIN	Used to guide timing optimization after global routing. It instructs the optimizer not to stop at zero slack and try to achieve a positive slack (the specified margin.)
GRT_RESIZER_HOLD_SLACK_MARGIN	Used to guide timing optimization after global routing. It instructs the optimizer not to stop at zero slack and try to achieve a positive slack (the specified margin.)
GRT_RESIZER_HOLD_MAX_BUFFER_PCT	Maximum % of hold buffers to insert to fix hold vios after global routing.
GRT_RESIZER_SETUP_MAX_BUFFER_PCT	Maximum % of hold buffers to insert to fix setup vios after global routing.
GRT_RESIZER_ALLOW_SETUP_VIOS	Allow setup violations while fixing hold violations after global routing.

Openlane2 Design Flow

Design Rule Check (DRC):

The design layout has to be checked against rules set by chip foundries to ensure that it can be manufacturable.



Openlane2 Design Flow

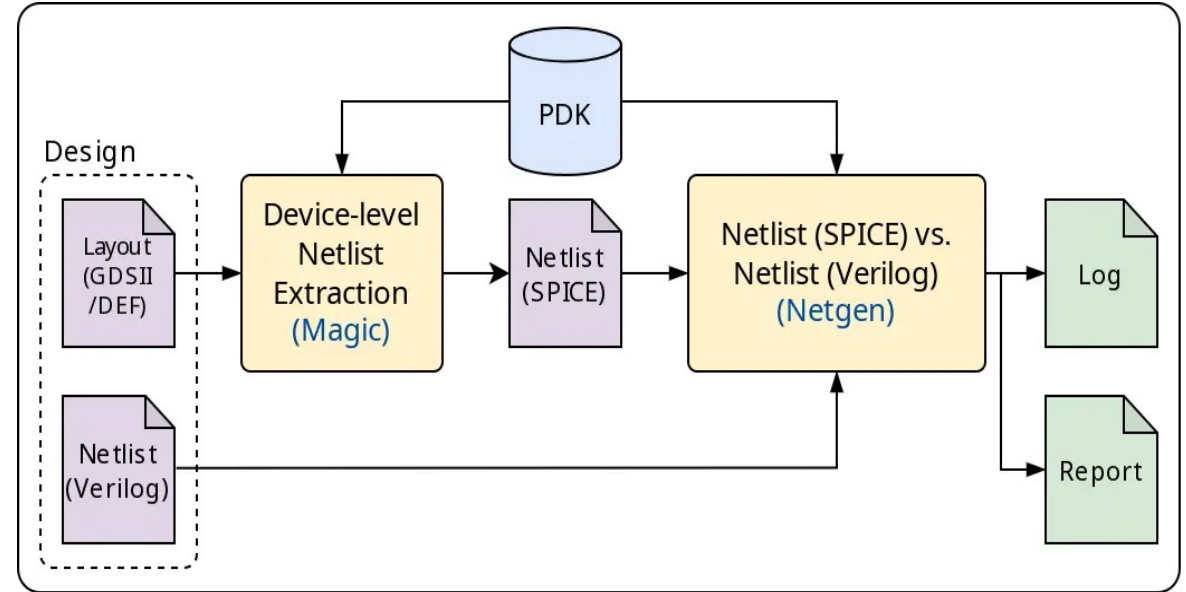
Layout Versus Schematic (LVS):

It compares the layout GDSII or DEF/LEF, with the schematic to ensure the connectivity in both views matches.

Some common LVS errors such as:

- Short: Two or more wires that should not be connected have been and must be separated. The most problematic is power and ground shorts.
- Open: Wires or components that should be connected are left dangling or only partially connected.
- Missing components: An expected components has been left out of the layouts. Normally some parasitic/dummy components need to be added to match with the layout

Netgen.LVS is the Step run for LVS using a tool called Netgen. First the layout is converted to SPICE netlist, Next, the layout and the schematic are inputted to Netgen



Subcircuit summary:

Circuit 1: pm32

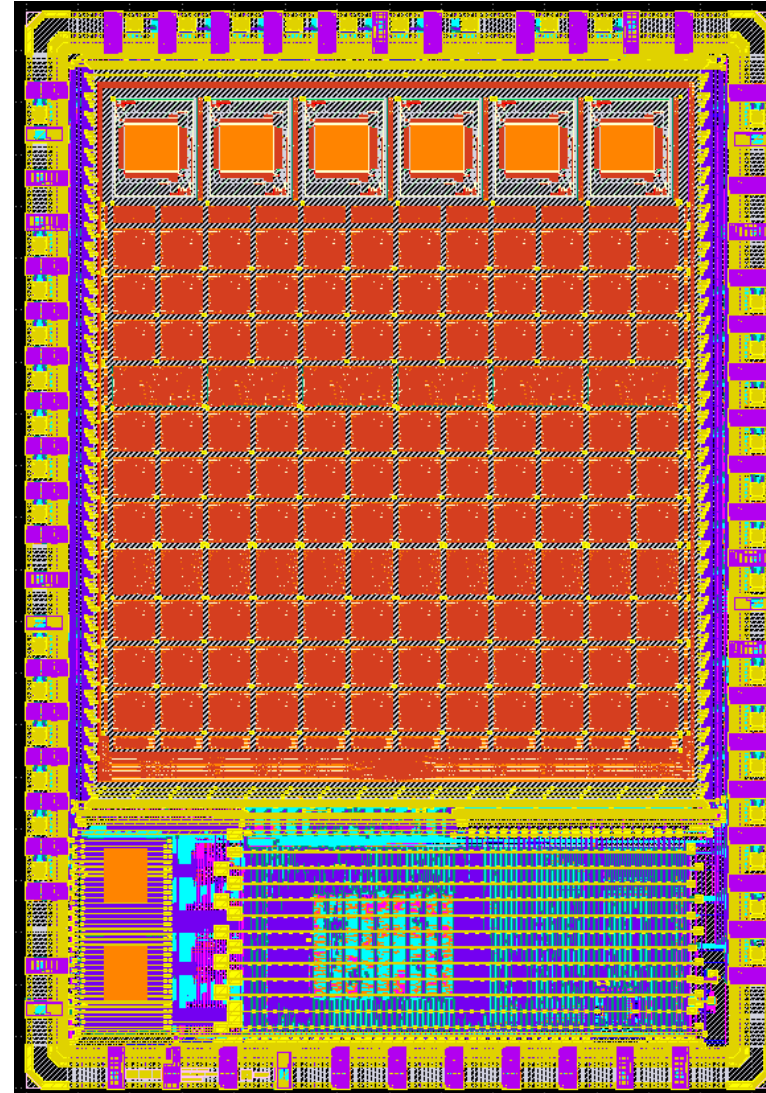
|Circuit 2: pm32

sky130_fd_sc_hd_tapvpwrvgnd_1 (102->1)
sky130_fd_sc_hd_decap_3 (144->1)
sky130_fd_sc_hd_inv_2 (64)
sky130_fd_sc_hd_nand2_1 (31)
sky130_fd_sc_hd_dfrtp_1 (64)
sky130_ef_sc_hd_decap_12 (132->1)

|sky130_fd_sc_hd_tapvpwrvgnd_1 (102->1)
|sky130_fd_sc_hd_decap_3 (144->1)
|sky130_fd_sc_hd_inv_2 (64)
|sky130_fd_sc_hd_nand2_1 (31)
|sky130_fd_sc_hd_dfrtp_1 (64)
|sky130_ef_sc_hd_decap_12 (132->1)

eFPGA design flow using Openlane

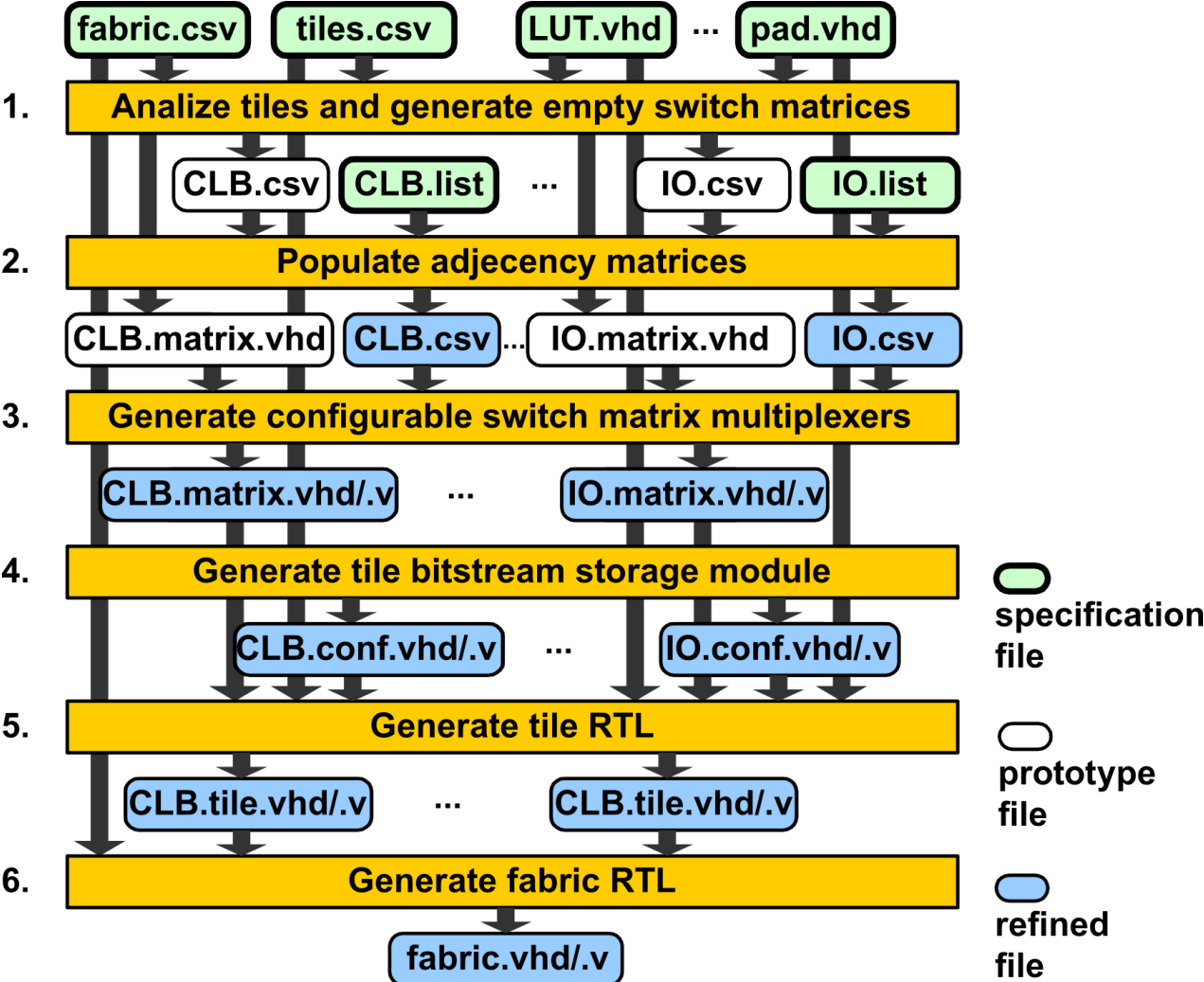
1. Create/Generate RTLs
2. Customize the cells (optional)
3. Hardening tiles (optional)
4. Hardening the fabric (eFPGA_top)/User project wrapper
5. Caravel Integration



eFPGA design flow using Openlane

1. Generate the fabrics (RTLs)

More details at <https://fabulous.readthedocs.io/en/latest/Building%20fabric.html>



eFPGA design flow using Openlane

2. Customize the cells (optional)

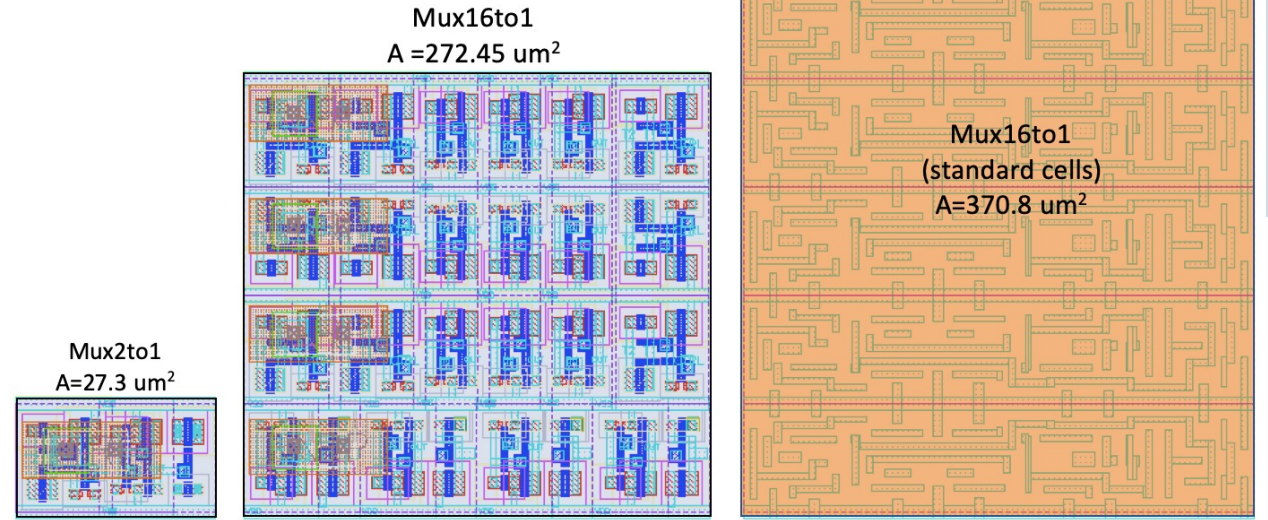
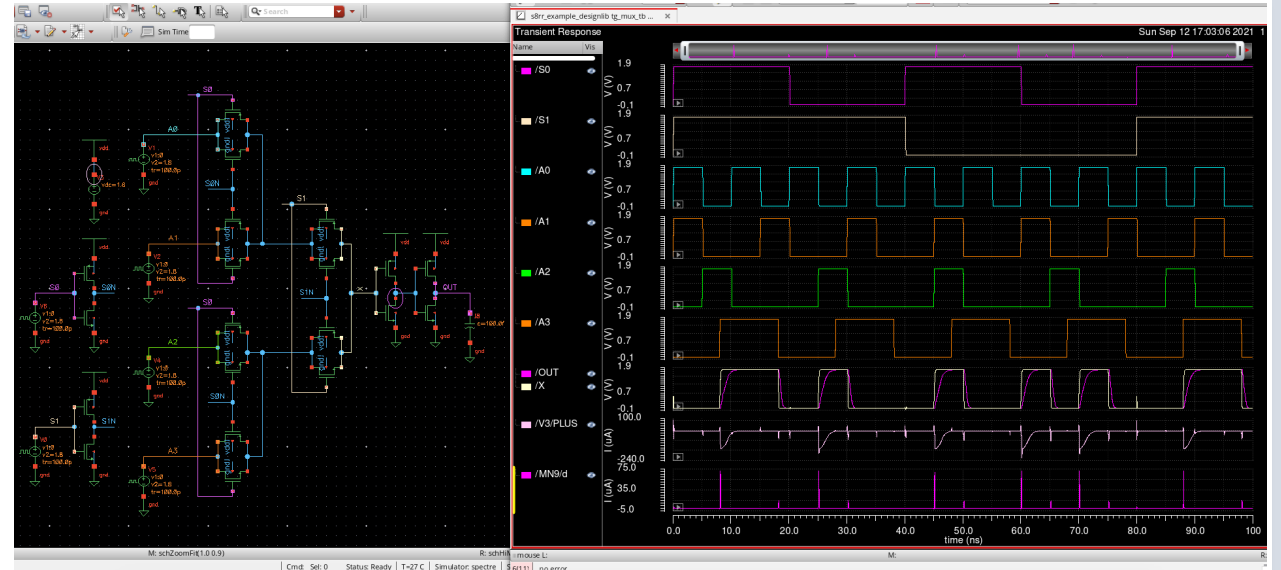
- 2.1. Create schematic
- 2.2. Simulation
- 2.3. Layout
- 2.4. Extract and do post-layout simulation
- 2.5. Export LEF/lib/GDS

```

VERSION 5.7 ;
NOWIREEXTENSIONATPIN ON ;
DIVIDERCHAR "/" ;
BUSBITCHARS "[]";
MACRO cus_tg_mux41_buf
CLASS CORE ;
FOREIGN cus_tg_mux41_buf ;
ORIGIN 0.000 0.000 ;
SIZE 6.440 BY 2.720 ;
SYMMETRY X Y R90 ;
SITE unithd ;
PIN S0
ANTENNAGATEAREA 0.216000 ;
DIRECTION INPUT ;
USE SIGNAL ;
PORT
LAYER met2 ;
RECT 1.980 1.310 2.300 1.570 ;
RECT 2.035 0.800 2.245 1.310 ;
RECT 1.995 0.480 2.255 0.800 ;
END
PORT
LAYER met1 ;
RECT 0.145 1.550 0.375 1.700 ;
RECT 1.980 1.550 2.300 1.570 ;
RECT 0.145 1.410 2.300 1.550 ;
RECT 1.980 1.310 2.300 1.410 ;
LAYER via ;
RECT 2.010 1.310 2.270 1.570 ;
END
END S0
...
END
END cus_tg_mux41_buf
    
```

```

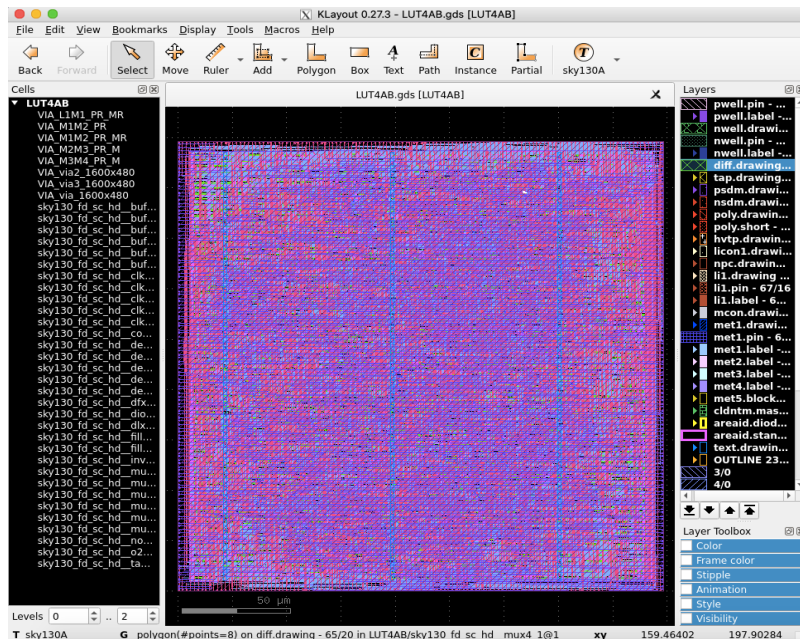
library ("custom_mux") {
define(def_sim_opt,library,string);
...
time_unit : "1ns";
voltage_unit : "1V";
leakage_power_unit : "1nW";
current_unit : "1mA";
pulling_resistance_unit : "1kohm";
capacitive_load_unit(1.0000000000, "pf"); ...
default_arc_mode : "worst_edges";
default_constraint_arc_mode : "worst";
default_leakage_power_density : 0.0000000000;
default_operating_conditions : "tt_025C_1v80";
operating_conditions ("tt_025C_1v80") {
voltage : 1.8000000000;
process : 1.0000000000;
temperature : 25.0000000000;
tree_type : "balanced_tree";
}
power_lut_template ("power_inputs_1") {
variable_1 : "input_transition_time";
index_1("1, 2, 3, 4, 5, 6, 7");
}
cell ("cus_tg_mux41_buf") {
leakage_power () {
value : 0.0137458000;
when : "!A0&!A1&!A2&!A3&!S0&S1";
}
related_pin : "S1";
rise_transition ("del_1_7_7") {
...
}
timing_sense : "negative_unate";
timing_type : "combinational";
}
}
    
```



eFPGA design flow using Openlane

3. Hardening tiles (optional)

- Configure the flow and design constraints (config.tcl)
- Initial/Set Technology/Lib and Top design
- Set area/density
- Set clock constraints
- Set technology/custom gates mapping
- Set IO pins arrangement
- Set Timing constraints (disable timing loops)
- Set routing constraints (layers/halos)



```
# User config
set ::env(DESIGN_NAME) LUT4AB
)

# Change if needed
set ::env(VERILOG_FILES) [glob $::env(DESIGN_DIR)/src/*.v]

# Use FP_CORE_UTIL to experiment the tile's size
#set ::env(FP_CORE_UTIL) 55

# Use FP_SIZING to fix the tile's area
set ::env(FP_SIZING) "absolute"
set ::env(DIE_AREA) "0 0 223.275 223.115"; #baseline LUT4AB(223.275 223.115)

#set ::env(PL_TARGET_DENSITY) [ expr ($::env(FP_CORE_UTIL)+5) / 100.0 ]
set ::env(PL_TARGET_DENSITY) 0.6

# Clock config
set ::env(CLOCK_PERIOD) "40"
set ::env(CLOCK_PORT) "UserCLK"
set ::env(CLOCK_TREE_SYNTH) 1

# Synthesis mode - should disable flattening the hierarchy that helps setting timing constraints later
# It also requires remove "-flatten" option at line 353 in scripts/yosys/synth.tcl
set ::env(SYNTH_NO_FLAT) 1

# DESIGN_IS_CORE 1 default, 0 is a macro
set ::env(DESIGN_IS_CORE) 0
set ::env(FP_PDN_CORE_RING) 0
set ::env(GLB_RT_MAXLAYER) 5

# Specify latch gate for mapping
set ::env(SYNTH_LATCH_MAP) $::env(DESIGN_DIR)/gate_map.v

# Change sdc file
set ::env(BASE_SDC_FILE) $::env(DESIGN_DIR)/LUT4AB.sdc

# Change the size and arrange the IO pins
set ::env(FP_IO_VLENGTH) 0.8
set ::env(FP_IO_HLENGTH) 0.8
set ::env(FP_IO_HTHICKNESS_MULT) 2
set ::env(FP_IO_VTHICKNESS_MULT) 2
set ::env(FP_IO_MODE) 0
set ::env(FP_PIN_ORDER_CFG) $::env(DESIGN_DIR)/pin_order.cfg

# Adjust the floorplan
set ::env(TOP_MARGIN_MULT) 2
set ::env(BOTTOM_MARGIN_MULT) 2

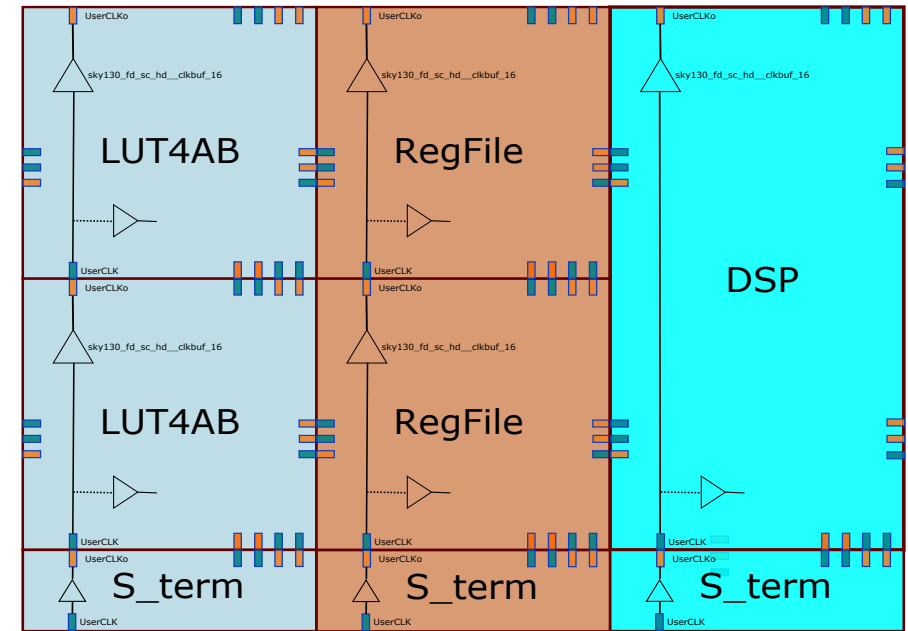
# Set the power pins
set ::env(VDD_PINS) "vccd1"
set ::env(GND_PINS) "vssd1"

set ::env(ROUTING_CORES) 12
```

eFPGA design flow using Openlane

3. Hardening tiles - Notes

- Need to add the lib/lef of the custom cells to the sky130 tech files
- Enable latch mapping – need to specify the latch used for configurations and specify the custom cells be used (gate_map.v)
- Enable hierarchical synthesis (`SYNTH_NO_FLAT=1`) to resist changing the module name during yosys synthesis
- Set Mux4 as preferable for better density (Yosys uses Mux2 as the default)
- RTL syntax, limited support for SystemVerilog e.g., global param/inherited param (#)
- Disable combinational loops by replacing the default `base.sdc`
- IO pins placement is limited (e.g., single metal layer only)
- Clock tree synthesis is limited (cannot handle a very large number of connections)

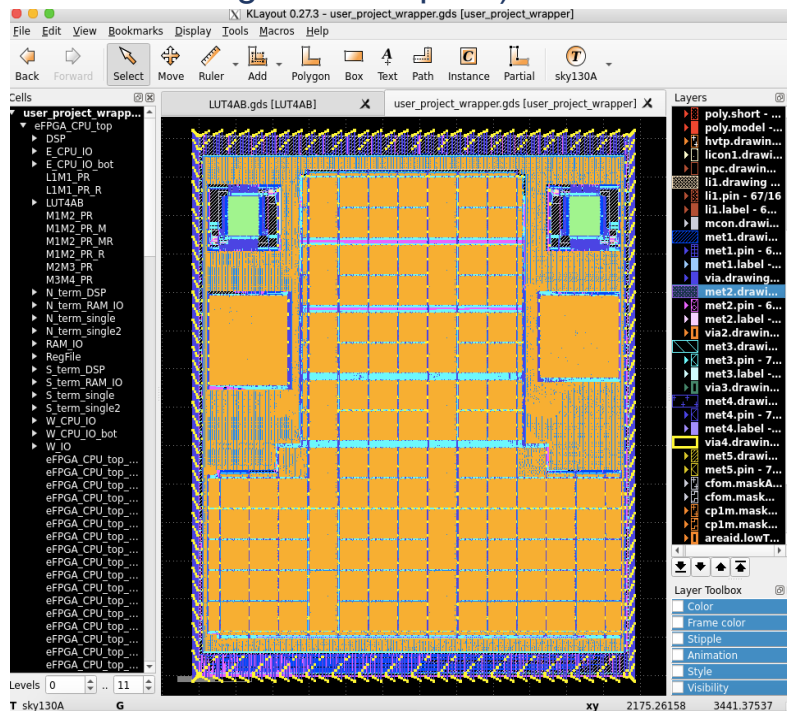


eFPGA design flow using Openlane

4. Hardening the User project (eFPGA_top fabric)

- Instantiate and connect the fabric (eFPGA_top) in User_project_wrapper.v
- Floorplan and Placement constraints
- Configure the Openlane flow and the design constraints
- Hardening the User_project_wrapper

(Note: the power rails can be unconnected to some tiles/macros if they are not in the range of PDN pitch)



```
set script_dir [file dirname [file normalize [info script]]]
source $::env(CARAVEL_ROOT)/openlane/user_project_wrapper/fixed_wrapper_cfgs.tcl
source $::env(CARAVEL_ROOT)/openlane/user_project_wrapper/default_wrapper_cfgs.tcl

set ::env(DSIGN_NAME) user_project_wrapper
set ::env(FP_PDN_ENABLE_RAILS) 1
set ::env(GLB_RT_OBS) "met1 0 0 $::env(DIE_AREA),\
                    met2 0 0 $::env(DIE_AREA),\
                    met3 0 0 $::env(DIE_AREA),\
                    met4 0 0 $::env(DIE_AREA),\
                    met5 0 0 $::env(DIE_AREA)"

set ::env(CLOCK_PORT) "user_clock2"
set ::env(CLOCK_NET) "inst_eFPGA_top.user_clock2"
set ::env(CLOCK_PERIOD) "40"

set ::env(PL_OPENPHYSYN_OPTIMIZATIONS) 0
set ::env(DIODE_INSERTION_STRATEGY) 5
set ::env(MAGIC_WRITE_FULL_LEF) 0

set ::env(SYNTH_FLAT_TOP) 1
set ::env(CLOCK_TREE_SYNTH) 1
set ::env(DESIGN_IS_CORE) 1
set ::env(STA_REPORT_POWER) 0
set ::env(SYNTH_USE_PG_PINS_DEFINES) "USE_POWER_PINS"
set ::env(VDD_NETS) {vccd1 vdda1 vdda2 vccd2}
set ::env(GND_NETS) {vssd1 vssa1 vssa2 vssd2}
set ::env(VDD_PIN) "vccd1"
set ::env(GND_PIN) "vssd1"
set ::env(PL_TARGET_DENSITY) 0.45
set ::env(CTS_TARGET_SKEW) 200
set ::env(CTS_SINK_CLUSTERING_SIZE) 100
set ::env(CTS_SINK_CLUSTERING_MAX_DIAMETER) 1000
set ::env(ROUTING_CORES) 12
set ::env(GLB_RT_MAXLAYER) 5
set ::env(FP_PDN_CHECK_NODES) 0
set ::env(FP_PDN_IRDROP) 0

set ::env(FP_TAP_HORIZONTAL_HALO) 20
set ::env(FP_TAP_VERTICAL_HALO) 20
set ::env(FP_PDN_HORIZONTAL_HALO) 30
set ::env(FP_PDN_VERTICAL_HALO) 30
set ::env(FP_PDN_VWIDTH) 1.6
set ::env(FP_PDN_VPITCH) 2800

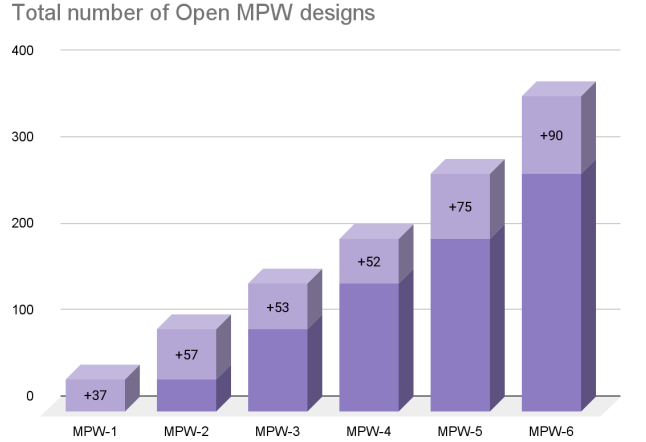
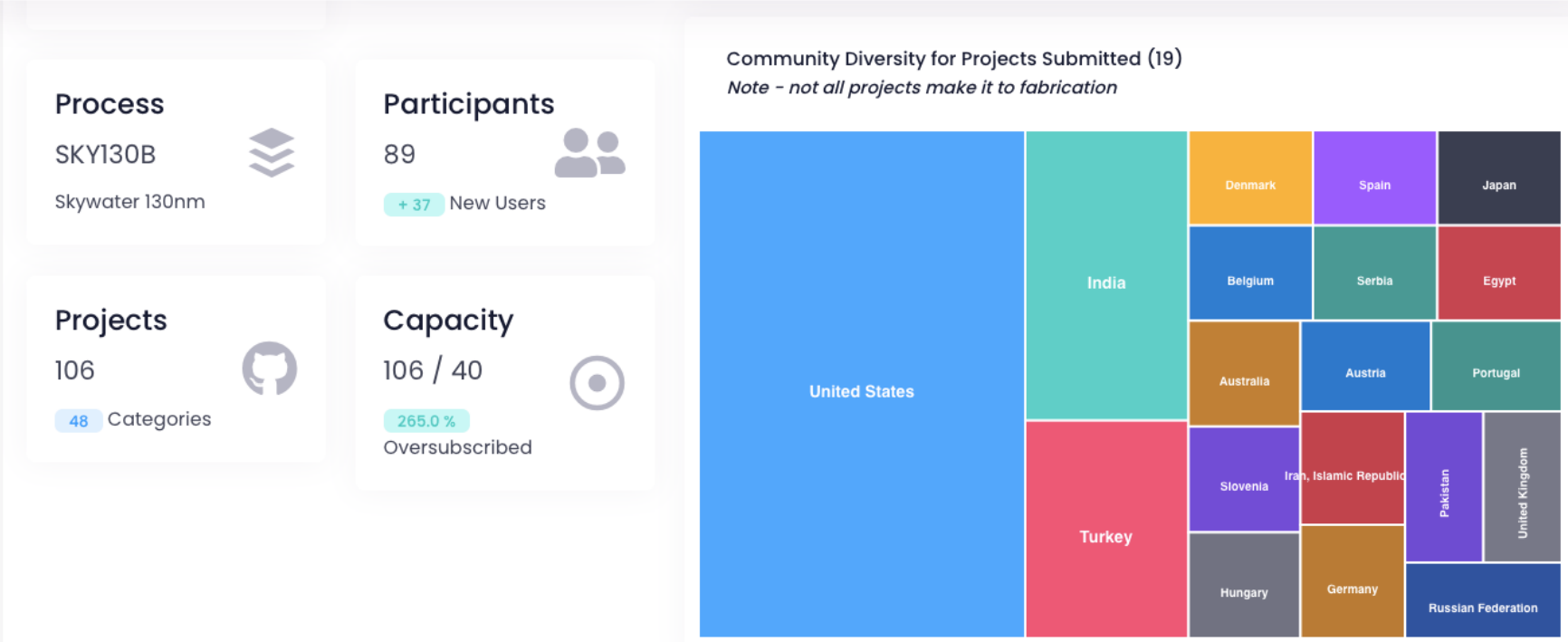
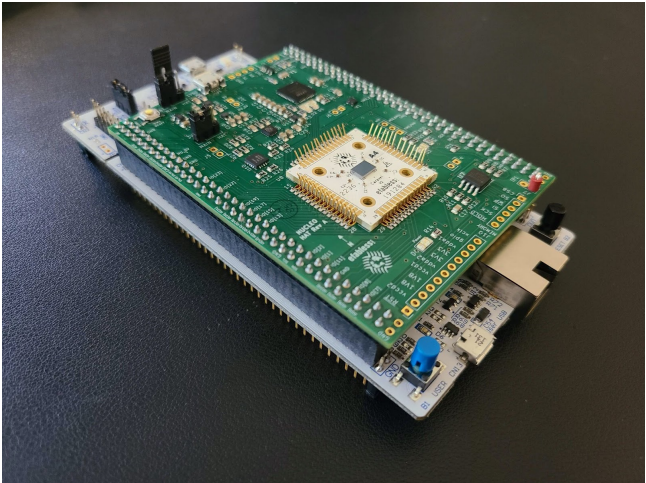
set ::env(SYNTH_READ_BLACKBOX_LIB) 1
set ::env(VERILOG_FILES) [glob $script_dir/../../verilog/rtl/defines.v $script_dir/../../verilog/rtl/*.v]
## Internal Macros
## Macro Placement
set ::env(MACRO_PLACEMENT_CFG) "$script_dir/../../openlane/user_project_wrapper/macros/placements/macro_placement.cfg"
## Black-box verilog and views
set ::env(VERILOG_FILES_BLACKBOX) [glob $script_dir/../../verilog/rtl/BB/*.v]
set ::env(EXTRA_LEFS) [glob $script_dir/../../openlane/user_project_wrapper/macros/lef/*.lef]
set ::env(EXTRA_GDS_FILES) [glob $script_dir/../../openlane/user_project_wrapper/macros/gds/*.gds]
## Macro PDN Connections
set ::env(FP_PDN_MACRO_HOOKS) "\
inst_eFPGA_top.Inst_eFPGA.Tile_X0Y1_W_IO vccd1 vssd1 \
inst_eFPGA_top.Inst_eFPGA.Tile_X0Y2_W_IO vccd1 vssd1 \
inst_eFPGA_top.Inst_eFPGA.Tile_X0Y3_W_IO vccd1 vssd1 \
```

eFPGA design flow using Openlane

- 5. Caravel Integration
- 6. Run local precheck
- 7. Submit precheck/tapeout job on eFables portal

>>> DONE !!!

MPW-7 | Open MPW



https://platform.efables.com/shuttles/MPW-7?active_tab=summary

Questions?

The screenshot shows a Slack interface for the #caravel channel. The channel name is #caravel, and the workspace is open-source-silicon. The channel has 430 members. The conversation is a thread starting with a message from Karla Julieth Camacho Mercado on October 2nd at 12:24 AM. She asks if it's possible to remove the caravel for an RFID project using SkyWater's 130nm technology, as it could affect performance. She mentions a larger space available for the chip design (3.2 x 5.3 mm instead of 2.92 x 3.52 mm). Other users respond, including Tim 'mithro' Ansell, Arman Avetisyan, Salman Faris, and Matt Venn. A message from Tim Edwards is also visible at the bottom of the thread.

Thread #caravel

Karla Julieth Camacho Mercado Oct 2nd at 12:24 AM
Hi everyone, I am working on an RFID project using SkyWater's 130nm technology and I am wondering if it is possible to remove the caravel, as this could affect the performance of the project significantly. If the caravel can be removed, have I a larger space available for the chip design? That is, I would have 3.2 x 5.3 mm instead of 2.92 x 3.52 mm ? Thank you in advance.

4 replies

Matt Venn 3 days ago
Not possible at the moment

Nguyen Dao 1 day ago
[@Tim Edwards](#) [@Matt Venn](#) is there an option if we also do a custom padframe fits to the current die area?

Matt Venn 1 day ago
No, it's not possible. It's being considered for future runs, but it will be announced in [#announcements](#) and on the public mailing lists if and when it happens.

Tim Edwards 10 hours ago
One thing you can do, though, which has been done before, is to create your entire design inside a custom padframe that fits inside the user area. There is no requirement to connect to the user project wrapper pins. That limits your total area considerably, but gives you complete freedom to do whatever you want with the area. Note, however, that you would need to do this on a ChipIgnite run, because all Open MPW runs are post-processed with bump bonding on top, which would interfere with any custom pads.

https://join.slack.com/t/open-source-silicon/shared_invite/zt-1hb6gydjo-C2NCyrjGtkAwWcaaRTSbNQ